Foil-Format Grease Replacement for Maximum Heat Transfer

Features and Benefits

- Thermal impedance: 0.22°C-in²/W (@50 psi)
- · Maximum heat transfer
- · Aluminum foil coated both sides
- Designed to replace thermal grease



Q-Pad II is a composite of aluminum foil coated on both sides with thermally / electrically conductive Sil-Pad rubber. The material is designed for those applications in which maximum heat transfer is needed and electrical isolation is not required. Q-Pad II is the ideal thermal interface material to replace messy thermal grease compounds.

Q-Pad II eliminates problems associated with grease such as contamination of reflow solder or cleaning operations. Unlike grease, Q-Pad II can be used prior to these operations. Q-Pad II also eliminates dust collection which can cause possible surface shorting or heat buildup.

TYPICAL PROPERTIES OF Q-PAD II						
PROPERTY	IMPERIAL VALUE		METRIC VALUE		TEST METHOD	
Color	Black		Black		Visual	
Reinforcement Carrier	Aluminum		Aluminum		_	
Thickness (inch) / (mm)	0.006		0.152		ASTM D374	
Hardness (Shore A)	93		93		ASTM D2240	
Continuous Use Temp (°F) / (°C)	-76 to 356		-60 to 180		_	
ELECTRICAL						
Dielectric Breakdown Voltage (Vac)	Non-Insulating		Non-Insulating		ASTM D149	
Dielectric Constant (1000 Hz)	NA		NA		ASTM D150	
Volume Resistivity (Ohm-meter)	10 ²		10 ²		ASTM D257	
Flame Rating	V-O		V-O		U.L.94	
THERMAL						
Thermal Conductivity (W/m-K)	2.5		2.5		ASTM D5470	
THERMAL PERFORMANCE vs PRESSURE						
Press	sure (psi)	10	25	50	100	200
TO-220 Thermal Performance (°C/W)		2.44	1.73	1.23	1.05	0.92
Thermal Impedance (°C-in²/W) (1)		0.52	0.30	0.22	0.15	0.12
1) The ASTM D5470 test fixture was used. The recorded value includes interfacial thermal resistance. These values are provided for						

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Typical Applications Include:

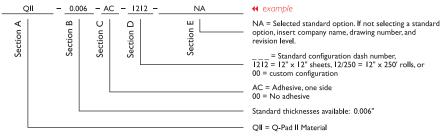
- Between a transistor and a heat sink
- Between two large surfaces such as an L-bracket and the chassis of an assembly
- Between a heat sink and a chassis
- Under electrically isolated power modules or devices such as resistors, transformers and solid state relays

Configurations Available:

- Sheet form, die-cut parts and roll form
- With or without pressure sensitive adhesive

Building a Part Number

Standard Options



Note: To build a part number, visit our website at www.bergquistcompany.com.

Sil-Pad*: U.S. Patents 4,574,879; 4,602,125; 4,602,678; 4,685,987; 4,842,911 and others

AMEYA360 Components Supply Platform

Authorized Distribution Brand:

























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